



# **K90DWN0-V1-F**

## **Product**

9 inch Diagonal 800 x 480 x RGB Dots 16.7M colors TFT display With white LED backlight With resistive touch screen

Kentec Electronics (Displays) Limited URL: <a href="http://www.kentecdisplay.com.hk">http://www.kentecdisplay.com.hk</a>

E-mail: t.liang@kentecdisplay.com.hk; mf.zou@kentecdisplay.com.hk

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1. Document revision history:

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DOCUMENT REVISION	DATE	DESCRIPTION	PREPARED BY	APPROVED BY			
01	2010.09.24	First Draft	MF				
	1	1	•				



#### 2. General Description

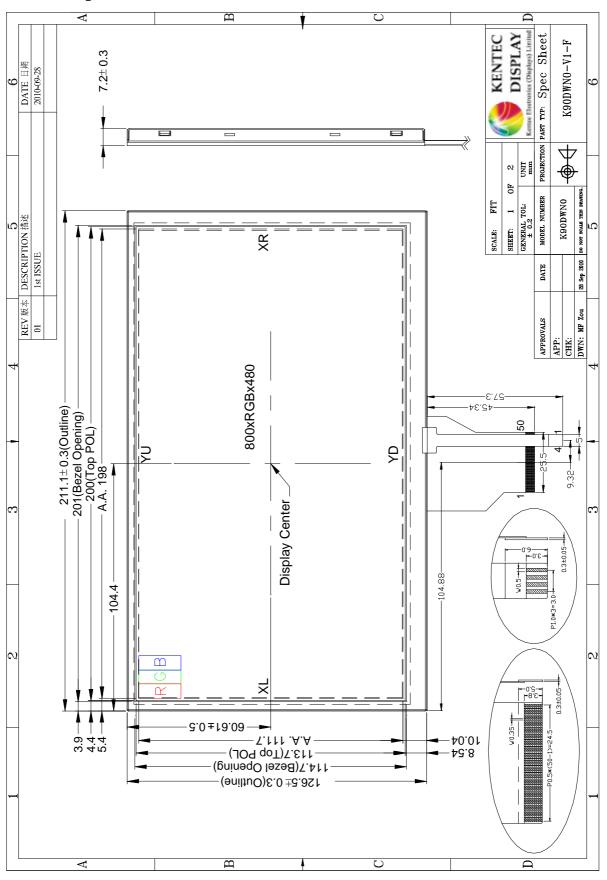
NO.	Item	Unit	Specification	Remark
1	Screen Size	inch	9 inch (Diagonal)	
2	Display Resolution	Dot	800RGB(W)x480(H)	
3	Overall Dimension	mm	211.1(W)x126.5(H)x7.2 (D)	Note 1
4	Active Area	mm	198.0(W)x111.7(H)	
5	Pixel Pitch	mm	0.2327(W)x0.2327(H)	
6	Color Configuration	-	Tri-Gate	
7	Color Depth	-	16.7M Color	Note 2
8	NTSC Ratio	%	50	
9	Display Mode	-	Normally White	
10	Panel Surface Treatment	-	Anti-Glare, 3H	
11	Weight	g	TBD	
12	Panel Power Consumption	mW	TBD	
13	<b>Backlight Power Consumption</b>	W	1.68	
14	Viewing Direction		6 o'clock(Gray inversion)	

Note 1: Not include backlight cable and FPC.

Note 2: Full color disiplay depends on 24-bit data signal.



#### 3. Mechanical Specifications



**Figure 1: Outline Drawing** 





4. Interface signals

	rtace signals	I/O	D '.'			
Pin No.	Symbol	I/O	Description			
1	VLED+	P	Power for LED backlight (Anode)			
2	VLED+	P	Power for LED backlight (Anode)			
3	VLED-	P	Power for LED backlight (Cathode)			
4	VLED-	P	Power for LED backlight (Cathode)			
5	GND	P	Ground			
6	VCOM	I	Common electrode driving voltage			
7	DVDD	P	Power for digital circuit			
8	MODE	I	DE/SYNC mode selection			
9	DE	I	Data enable input (High active)			
10	VS	I	Vertical Sync input			
11	HS	I	Horizontal Sync input			
12	DB7	I	Blue data input (MSB)			
13	DB6	I	Blue data input			
14	DB5	I	Blue data input			
15	DB4	I	Blue data input			
16	DB3	I	Blue data input			
17	DB2	I	Blue data input			
18	DB1	I	Blue data input			
19	DB0	I	Blue data input (LSB)			
20	DG7	I	Green data input (MSB)			
21	DG6	I	Green data input			
22	DG5	I	Green data input			
23	DG4	I	Green data input			
24	DG3	I	Green data input			
25	DG2	I	Green data input			
26	DG1	I	Green data input			
27	DG0	I	Green data input (LSB)			
28	DR7	I	Red data input (MSB)			
29	DR6	I	Red data input (WISB)  Red data input			
30	DR5	I	Red data input  Red data input			
31	DR3 DR4	I	Red data input  Red data input			
32		I	1			
	DR3		Red data input			
33	DR2	I	Red data input			
34	DR1	l T	Red data input			
35	DR0	I	Red data input			
36	GND	P	Ground			
37	DCLK	I	Data clock input			
38	GND	P	Ground			
39	L/R	I	Left/Right scan direction selection			
40	U/D	I	Up/Down scan direction selection			
41	VGH	P	Positive power supply voltage for Gate driver			
42	VGL	P	Negative power supply voltage for Gate driver			
43	AVDD	P	Power for analog circuit			
44	RESET	I	H/W global reset			
45	NC	-	No connection			
46	VCOM	I	Common electrode driving voltage			
47	DITHB	I	Dithering enable			
48	GND	P	Ground			
49	NC	-	No connection			
50	NC	_	No connection			

Note: Connector Type: 50Pin 0.5mm pitch. Recommended Connector: FH12A-50S-0.5H(Hirose)



### **5. Absolute Maximum Ratings**

Table 3: Electrical Maximum Ratings

Parameter	Symbol	Condition	Min.	Max.	Unit	Note
	DVDD	GND=0V	-0.5	5.0	V	
	AVDD	GND=0V	6.5	13.5	V	
Power voltage	VGH	GND=0V	-0.3	40	V	
	VGL	GND=0V	-20	0.3	V	
	VGH-VGL	-	-	40	V	
Input signal	Vi	GND=0V	-0.3	DVDD+0.3	V	
voltage	VCOM	GND=0V	TBD	TBD	V	
Operation	Topa		-10	60		
temperature	Тора		-10	00		
Storage	Tstg		-20	70		
temperature	Taig		-20	70		

#### **6. Electrical Specifications**

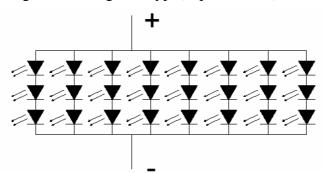
#### **Typical Electrical Characteristics**

At Ta = 25 °C, DVCC= 3.3V, GND=0V.

Table 5

Parameter		Symbol	Min.	Typ.	Max.	Unit	Remark
		DVDD	3	3.3	3.6	V	
Power su	nnly	AVDD	(10.2)	(10.4)	(10.6)	V	
1 Ower su	ppry	VGH	(15.3)	(16.0)	(16.7)	V	
		VGL	(-7.7)	(-7.0)	(-6.3)	V	
Input signal	VCOM	Vcom	TBD	TBD	TBD		
voltage	H level	Vih	0.7DVDD		DVDD	V	
voltage	L level	Vil	0		0.3DVDD	V	
1 1 2	Supply current (Logic & LCD)		TBD	TBD	TBD	mA	
Supply voltage of LED backlight		VLED	(9.3)	(9.9)	(10.5)	V	
Supply current of LED backlight		ILED	-	(120)	(160)	mA	Note 1
Power consu	ımption	P	-	1.68	-	W	

Note 1: LED backlight is LED lightbar type(24pcs of LED).





#### 7. Optical Characteristics

Table 6: Optical specifications

Items		Symbol	Condition	Spe	ecificatio	ns	Unit	
Itellis		Symbol	Condition	Min.	Тур.	Max.	Omt	
Luminano	ce	Lw		200	250	-	cd/m <sup>2</sup>	
Contrast Ra	atio	CR		400	500	-	-	
Response T	ime	$T_R + T_F$		-	25	50	ms	Note
Chromaticity	White	$X_{\mathrm{W}}$		(0.26)	(0.31)	(0.36)	ı	
Cinomaticity	vv iiite	$Y_{W}$		(0.28)	(0.33)	(0.38)	1	
Viewing angle	Hor.	$\phi 1 + \phi 2$	Center	120	140	-	dog	
viewing angle	Ver.	$\theta 1 + \theta 2$	CR=10	100	120	-	deg.	

Note 1: Definition of Contrast Ratio (CR):

The contrast ratio can be calculated by the following expression.

Contrast Ratio (CR) = L63 / L0

L63: Luminance of gray level 63

L0: Luminance of gray level 0

CR = CR (10)

CR (X) is corresponding to the Contrast Ratio of the point X at Figure in Note 5.

Note 2: Definition of Response Time (TR, TF):

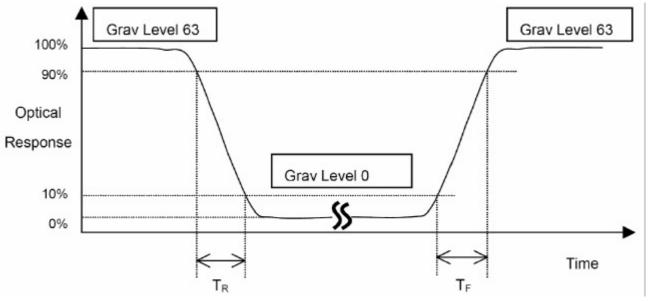


Figure 3



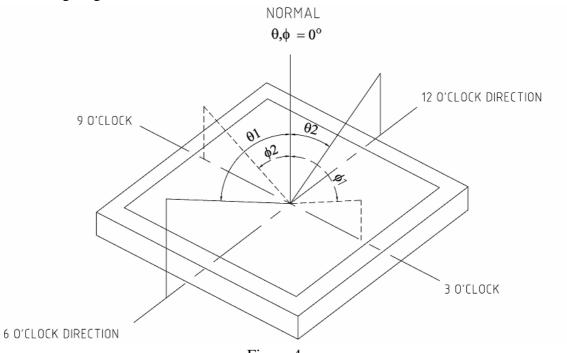


Figure 4

The above "Viewing Angle" is the measuring position with Largest Contrast Ratio; not for good image quality. View Direction for good image quality is 6 O'clock. Module maker can increase the "Viewing Angle" by applying Wide View Film.

#### Note 4: Measurement Set-Up:

The LCD module should be stabilized at a given temperature for 20 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 20 minutes in a windless room.

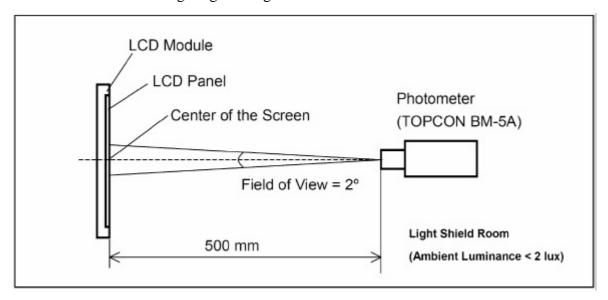


Figure 5



#### 8. AC Characteristics

#### 8.1 Power on/off sequence

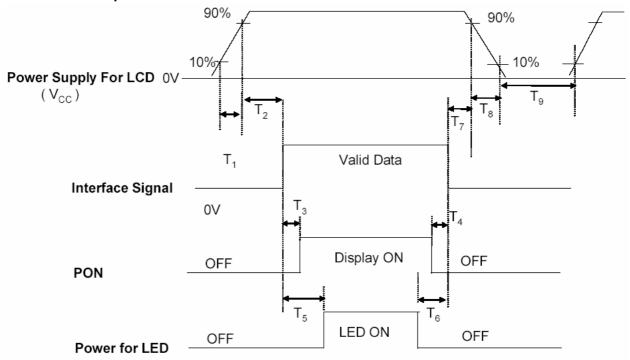


Table 6: Power on/off sequence table

Parameter		Value	Unito	
Parameter	Min.	Тур.	Max.	Units
T <sub>1</sub>	0.5	-	10	(ms)
T <sub>2</sub>	0	-	50	(ms)
T <sub>3</sub>	20	-	-	(ms)
T <sub>4</sub>	20	-	-	(ms)
T <sub>5</sub>	200	-	-	(ms)
T <sub>6</sub>	200	-	-	(ms)
T <sub>7</sub>	0	-	50	(ms)
T <sub>8</sub>	0	-	10	(ms)
T <sub>9</sub>	400	-	-	(ms)



#### 8.2 Signal timing (VDD=3.3V)

#### 8.2.1 Signal input waveform

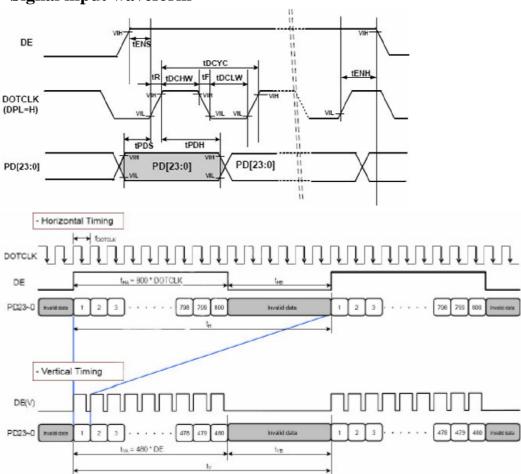


Table 6: Signal timming (At 60Hz framerate)

	Item	Symbol	Min.	Тур.	Max.	Unit	Remarks
	Frame frequency		50	60	70	Hz	1
	Frequency	fCLK	31.95	33.26	34.60	MHz	
	Period	tDCYC	28.90	30.06	31.30	ns	
DCLK	DOTCLK rise/fall time	tR, tF	-	-	2	ns	
	High Level Width	tDCHW	9	-	-	ns	
	Low Level Width	tDCLW	9	-	-	ns	
DATA	Setup Time	tENS	5	1	1	ns	
DATA	Hold Time	tENH	5	-	-	ns	
	Setup Time	tPDS	5	-	1	ns	
	Hold Time	tPDH	5	-	-	ns	
	Horizontal Active Period	tHA	-	(800)	1	CLK	
DE	Horizontal Blank Period	tHB	(175)	(217)	(256)	CLK	
DE	Horizontal Period	tH	(975)	(1017)	(1056)	CLK	
	Vertical Active Period	tVA	-	(480)	-	CLK	
	Vertical Blank Period	tVB	(25)	(28)	(53)	CLK	
	Vertical Period	tV	(505)	(508)	(533)	CLK	



## 9. Reliability Test Item

	Test Item	Test Condition	Remark
1	High temperature storage	70 ; 240H	
2	Low temperature storage	-20 ; 240H	
3	High temperature High humidity	50 , 80%RH; 240H	Operation
4	High temperature operation	60 ; 240H	
5	Low temperature operation	-10 ; 240H	
6	Temperature Shock	-20 ? 60 ; 100cycle, 1Hrs/cycle	Non-operation
7	Electrostatic Discharge	Contact ± 4kV, Class B Air ± 8kV, Class B	
8	Image sticking	25 , 4H	
9	Vibration	Frequency range: 10~55Hz Stoke: 1.5mm Sweep: 10~55~10Hz 2 Hours for each direction of X,Y,Z (total 6 Hours)	Non-operation JIS C7021, A-10 Condiction A: 15 minutes
10	Mechanical shock	100G, 6ms, ±X, ±Y, ±Z, 3 times for each direction	Non-operation JIS C7021, A-10 Condiction C
11	Vibration (with carton)	Random vibration: 0.015G <sup>2</sup> /Hz from 2~200Hz -6dB/Octave from 200~500Hz	ICE 68-34
12	Drop (with carton)	Height: 60cm 1 corner, 3 edges, 6 surfaces	
13	Pressure	5 kg, 5 sec	



#### 10. Suggestions for using LCD modules

#### **10.1 Handling of LCM**

- 1. The LCD screen is made of glass. Don't give excessive external shock, or drop from a high place.
- 2. If the LCD screen is damaged and the liquid crystal leaks out, do not lick and swallow. When the liquid is attach to your hand, skin, cloth etc, wash it off by using soap and water thoroughly and immediately.
- 3. Don't apply excessive force on the surface of the LCM.
- 4. If the surface is contaminated ,clean it with soft cloth. If the LCM is severely contaminated , use Isopropyl alcohol/Ethyl alcohol to clean. Other solvents may damage the polarizer . The following solvents is especially prohibited: water , ketone Aromatic solvents etc.
- 5. Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
- 6. Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.
- 7. Don't disassemble the LCM.
- 8. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
  - Be sure to ground the body when handling the LCD modules.
  - Tools required for assembling, such as soldering irons, must be properly grounded.
  - To reduce the amount of static electricity generated, do not conduct assembling and other work under dry conditions.
  - The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.
- 9. Do not alter, modify or change the the shape of the tab on the metal frame.
- 10. Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.

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- 11. Do not damage or modify the pattern writing on the printed circuit board.
- 12. Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector
- 13. Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
- 14. Do not drop, bend or twist LCM.

#### 10.2 Storage

- 1. Store in an ambient temperature of 5 to 45 °C, and in a relative humidity of 40% to 60%. Don't expose to sunlight or fluorescent light.
- 2. Storage in a clean environment, free from dust, active gas, and solvent.
- 3. Store in antistatic container.

# 11. Packing Method TBD

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